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**(54) HEAT-CONDUCTIVE
FLAME-RETARDANT
PRESSURE-SENSITIVE
ADHESIVE AND
PRESSURE-SENSITIVE
ADHESIVE TAPE**

(57) Abstract:

PROBLEM TO BE SOLVED: To provide an electrical insulation heat-conductive flame-retardant pressure-sensitive adhesive and a pressure-sensitive adhesive tape each of which can bond a heat sink or the like to an electronic component in improved workability and can transmit the heat generated by an electronic component to a heat dissipation apparatus such as a heat sink at good efficiency to prevent the electronic component from an error.

SOLUTION: There is provided an electric insulation heat-conductive flame-retardant pressure-sensitive adhesive comprising 100 pts.wt. pressure-sensitive adhesive composition comprising 100 pts.wt. acrylic copolymer or partial polymer